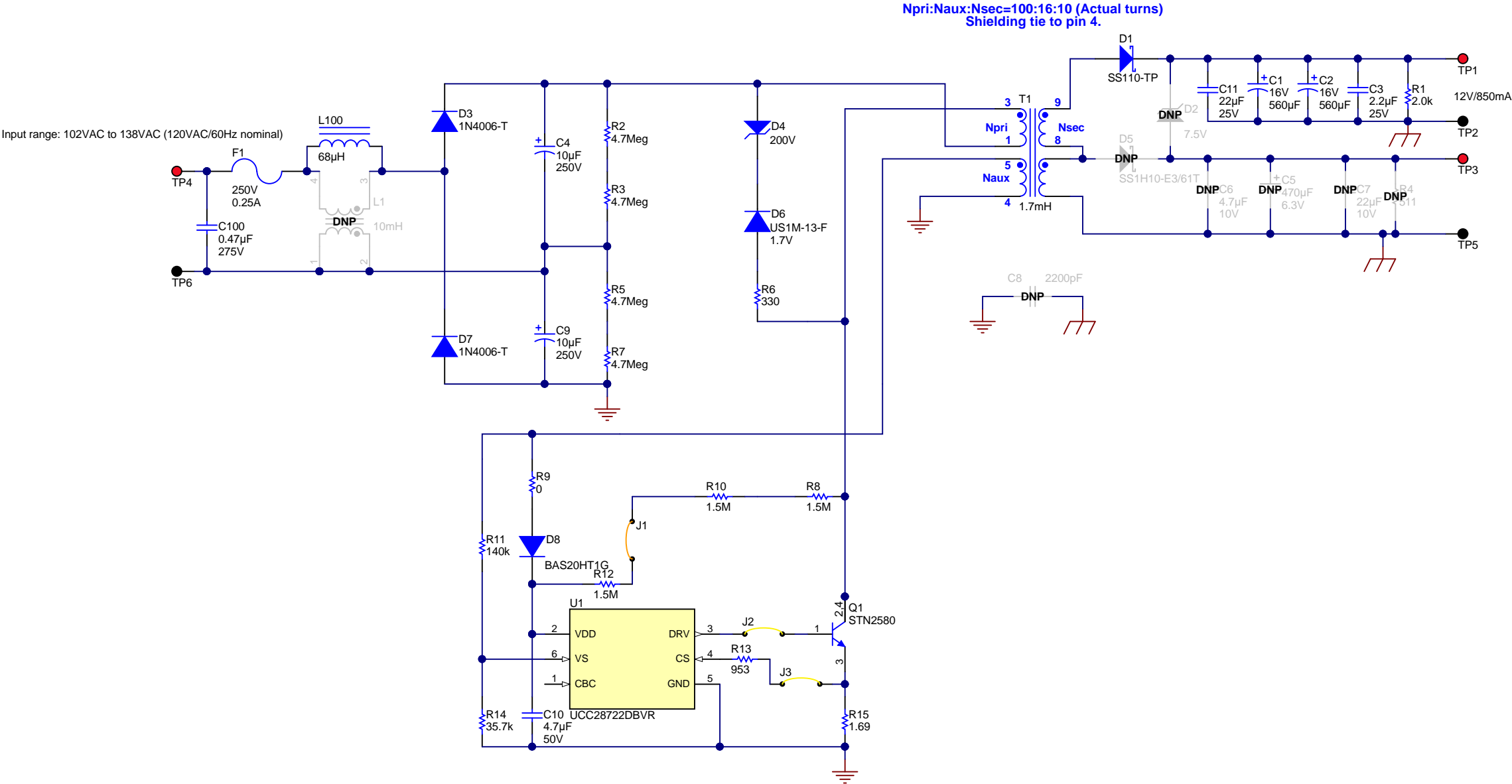


Note: C100 and L100 are add-on parts.



Built on PMP20315 RevA PCB.

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TID #: <a href="#">N/A</a>	Project Title: <a href="#">UCC28722 dual-output Flyback</a>	
Number: <a href="#">PMP21022</a>	Rev: <a href="#">A</a>	Sheet Title:
SVN Rev: <a href="#">Version control disabled</a>	Assembly Variant: <a href="#">001</a>	Sheet: <a href="#">1</a> of <a href="#">1</a>
Drawn By:	File: <a href="#">PMP20315_BlankSheet.SchDoc</a>	Size: <a href="#">B</a>
Engineer: <a href="#">Sheng-Yang Yu</a>	Contact: <a href="#">http://www.ti.com/support</a>	

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
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